

# RJK0355DPA

# Silicon N Channel Power MOS FET Power Switching

REJ03G1649-0500 Rev.5.00 Aug 05, 2008

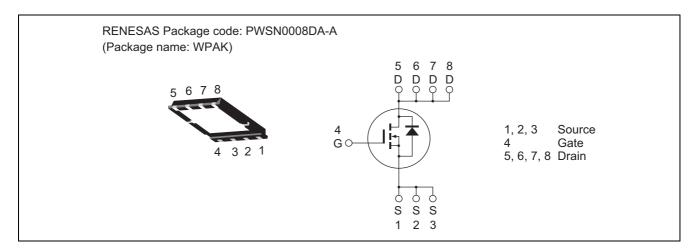
### **Features**

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS(on)} = 8.2 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V})$ 

• Pb-free

# **Outline**



# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	30	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	30	A
Drain peak current	I <sub>D(pulse)</sub> Note1	120	A
Body-drain diode reverse drain current	I <sub>DR</sub>	30	A
Avalanche current	I <sub>AP</sub> Note 2	9	A
Avalanche energy	E <sub>AR</sub> Note 2	8.1	mJ
Channel dissipation	Pch Note3	25	W
Channel to case thermal resistance	θch-c Note3	5	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1.  $PW \le 10 \mu s$ , duty cycle  $\le 1\%$ 

- 2. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$
- 3.  $Tc = 25^{\circ}C$

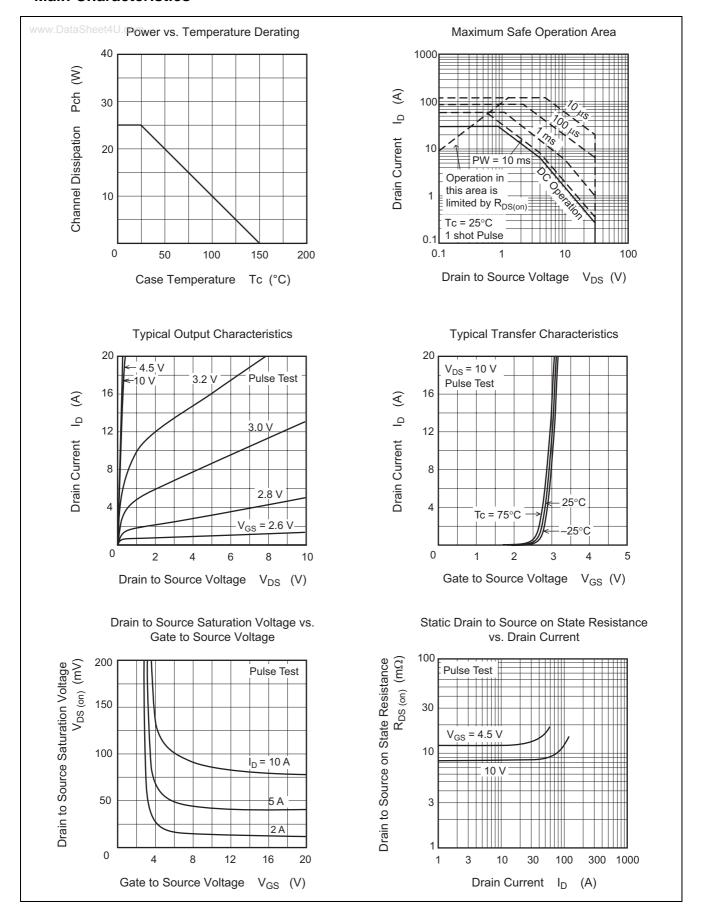
# **Electrical Characteristics**

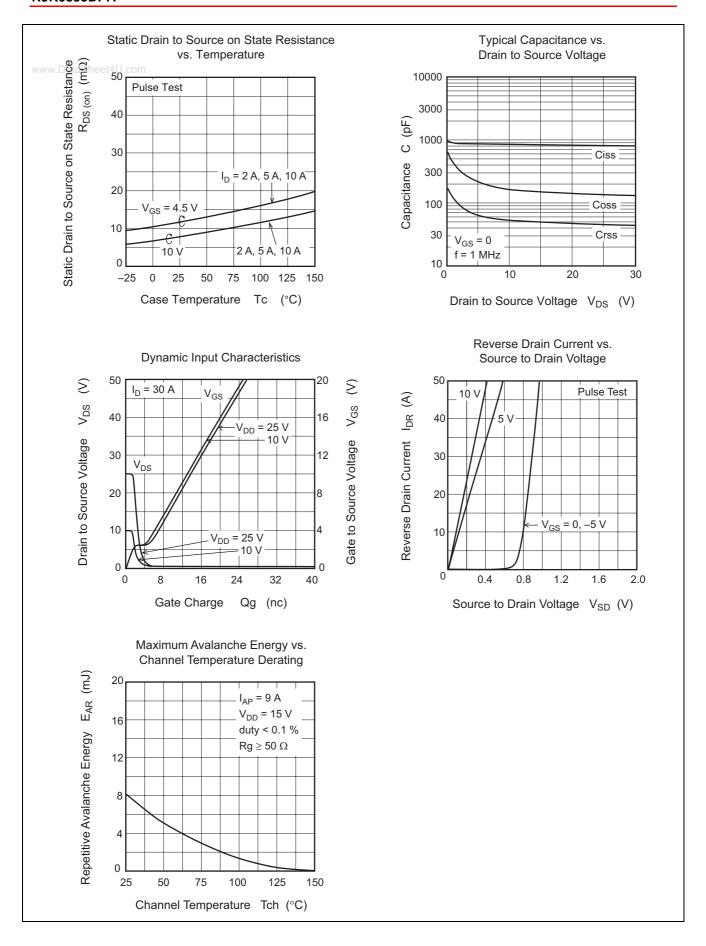
 $(Ta = 25^{\circ}C)$ 

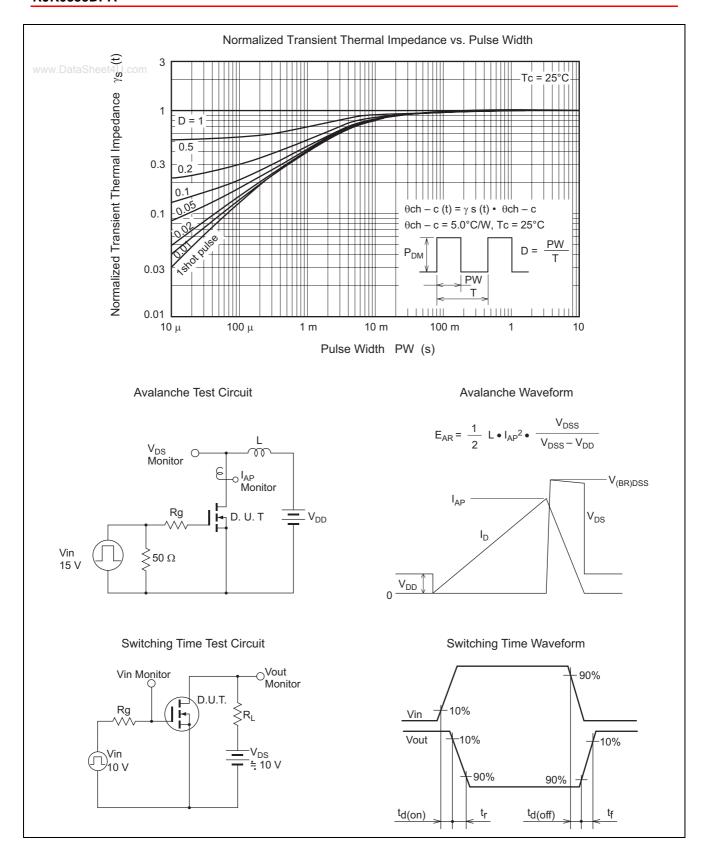
Item	Symbol	Min	Тур	Max	Unit	Test Conditions	
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to source leak current	I <sub>GSS</sub>	_	_	± 0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$	
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$	
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.2	_	2.5	<b>V</b>	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	
Static drain to source on state	R <sub>DS(on)</sub>	_	8.2	10.7	mΩ	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$	
resistance	R <sub>DS(on)</sub>	_	11.8	16.5	mΩ	$I_D = 15 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$	
Forward transfer admittance	y <sub>fs</sub>	_	55	_	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$	
Input capacitance	Ciss	_	860	_	pF	V <sub>DS</sub> = 10 V	
Output capacitance	Coss	_	165	_	pF	$V_{GS} = 0$	
Reverse transfer capacitance	Crss	_	53	_	pF	f = 1 MHz	
Gate Resistance	Rg	_	4.2	_	Ω		
Total gate charge	Qg	_	6.3	_	nC	$V_{DD} = 10 \text{ V}$	
Gate to source charge	Qgs	_	2.3	_	nC	$V_{GS} = 4.5 \text{ V}$	
Gate to drain charge	Qgd	_	1.4	_	nC	$I_D = 30 \text{ A}$	
Turn-on delay time	t <sub>d(on)</sub>	_	6.9	_	ns	$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$	
Rise time	t <sub>r</sub>	_	4.1	_	ns	$V_{DD} \cong 10 \text{ V}$	
Turn-off delay time	t <sub>d(off)</sub>	_	40.8	_	ns	$R_L = 0.66 \Omega$	
Fall time	t <sub>f</sub>	_	5.6	_	ns	$Rg = 4.7 \Omega$	
Body-drain diode forward voltage	$V_{DF}$	_	0.87	1.14	V	$I_F = 30 \text{ A}, V_{GS} = 0^{\text{Note4}}$	
Body-drain diode reverse recovery	t <sub>rr</sub>	_	20	_	ns	I <sub>F</sub> =30 A, V <sub>GS</sub> = 0	
time						$di_F/dt = 100 A/ \mu s$	

Notes: 4. Pulse test

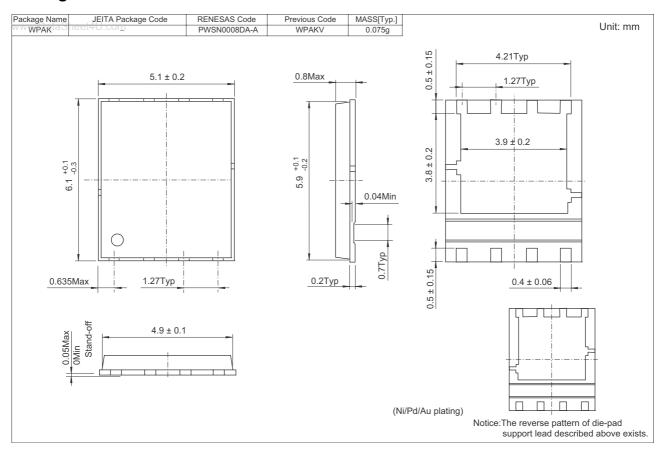
# **Main Characteristics**







# **Package Dimensions**



# **Ordering Information**

Part No.	Quantity	Shipping Container
RJK0355DPA-00-J0	2500 pcs	Taping

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